

ID	R <sub>DS</sub> (ON)(Typ)	VDSS
78A	8.2mΩ	100V
• 100% a	<b>s:</b> vitching speed avalanche tested ved dv/dt capability	

#### **Ordering Information**

Part Number	Package	Marking	Packing	Qty.
RS100N78T	T0-220	RS100N78T	Tube	50 PCS

## Absolute Maximun Ratings Tc= $25^{\circ}$ unless otherwise specified

Symbol	Parameter	RS100N78T	Units
VDSS	Drain-to-Source Voltage	100	V
ID	Continuous Drain Current TC=25℃	78	
ID	Continuous Drain Current TC=100°C	45	А
IDM	Pulsed Drain Current	312	
PD	Power Dissipation	78	W
VGS	Gate- to- Source Voltage	±20	V
EAS	Single Pulse Avalanche Engergy L = 0.5mH,VDS = 50V, RG = 25Ω, Tj = 25℃	81	mJ
	Maximum Temperature for Soldering		
TL TPKG	Leads at 0.063in(1.6mm)from Case for 10 seconds Package Body for 10 seconds	300 260	°C
TJ and TSTG	Operating Junction and Storage Temperature Range	-55 to 150	

\* Drain Current Limited by Maximum Junction Temperature

Caution: Stresses greater than those listed in the "Absolute Maximum Ratings" Table may cause permanent damage to the device.



# **Thermal Resistance**

Symbol	Parameter	RS100N78T	Units	Test Conditions
RØJC	Junction-to-Case	1.6	°C/W	Drain lead soldered to water cooled heatsink, PD adjusted for a peak junction temperature of + 1 5 0 $^\circ\!\!C$
RθJA	Junction-to- Ambient	50		1 cubic foot chamber,free air.

## **OFF Characteristics** TJ= $25^{\circ}$ C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
BVDSS	Drain- to- source Breakdown Voltage	100			V	VGS=0V,ID=250μ Α
IDSS	Drain- to- Source Leakage Current			1	μA	VDS=80V,VGS=0 V
	Gate- to- Source Forward Leakage			100	- 4	VGS=20V ,VDS=0 V
IGSS	Gate- to- Source Reverse Leakage			-100	nA	VGS=-20V ,VDS= 0V

## **ON Characteristics** TJ=25°C unless otherwise specified

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
RDS(on)	Static Drain- to- Source On- Resistance		8.2	9.5	mΩ	VGS=10V,ID=20A
			11.3	13.5	mΩ	VGS=4.5V,ID=10 A
VGS(TH )	Gate Threshold Voltage	1.2	1.8	2.6	V	VGS=VDS,ID=25 0μA

# **Resistive Switching Characteristics** Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
td(ON)	Turn- on Delay Time		17		- nS	VDS=50V ID=20A RG=3Ω VGS=10V
trise	Rise Time		4			
td(OFF)	Turn- OFF Delay Time		32			
tfall	Fall Time		8			



#### **Dynamic Characteristics** Essentially independent of operating temperature

Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions
Ciss	Input Capacitance		2018			VGS= 0V
Coss	Output Capacitance		580		pF	VDS=50V
Crss	Reverse Transfer Capacitance		28			f=1MHz
Qg	Total Gate Charge		38.5			VDS= 50V
Qgs	Gate- to- Source Charge		8		nC	ID=20A
Qgd	Gate-to-Drain(" Miller") Charge		9			VGS=10V

#### **Source- Drain Diode Characteristics**

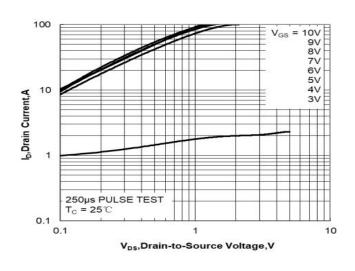
Symbol	Parameter	Min.	Тур.	Max.	Units	Test Conditions	
IS	Continuous Source Current			78	А	Integral pn- diode	
ISM	Maximum Pulsed Current			312	А	in MOSFET	
VSD	Diode Forward Voltage			1.0	V	IS=20A,VGS=0V	
trr	Reverse Recovery Time		50.4		nS	VGS=0V	
Qrr	Reverse Recovery Charge		68		nC	IS=20A di/dt=100A/μs	

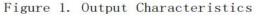
Notes:

\* 1. Repetitive rating, pulse width limited by maximum junction temperature.

\* 2. Pulse Test: Pulse width  $\leq$  300µs, Duty Cycle  $\leq$  1%

## **Typical Feature Curve**





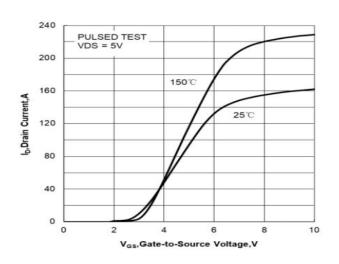
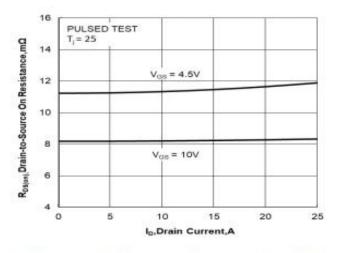
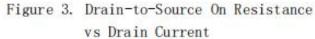
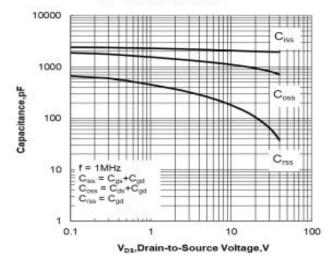


Figure 2. Transfer Characteristics

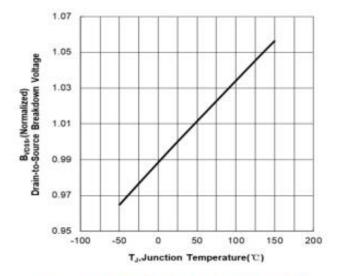


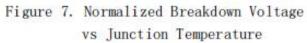












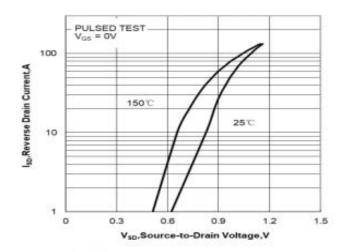


Figure 4.Body Diode Forward Voltage vs Source Current and Temperature

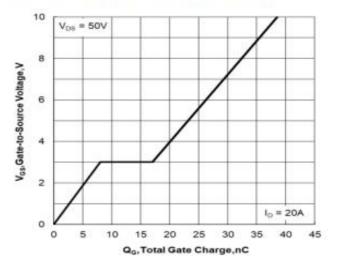
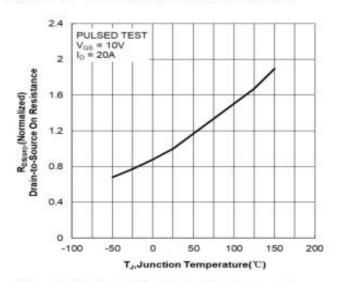
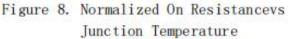


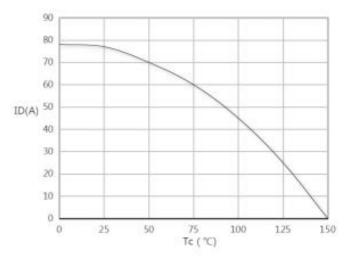
Figure 6. Gate Charge Characteristics

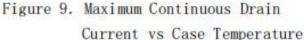


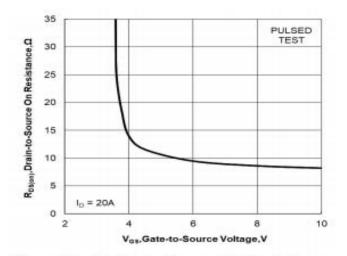


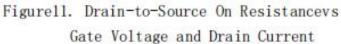
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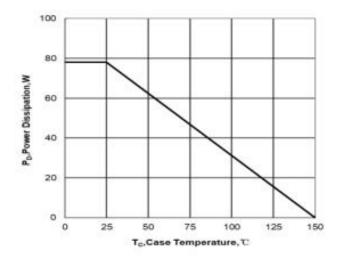


Figure 10. Maximum Power Dissipation vs Case Temperature

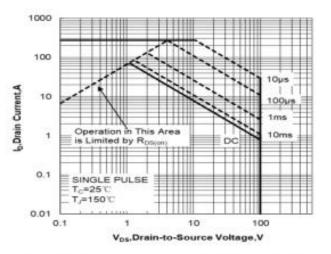


Figure 12. Maximu Safe Operating Area

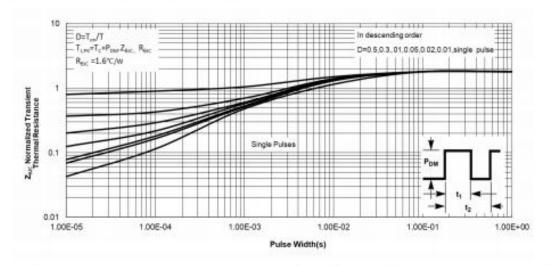
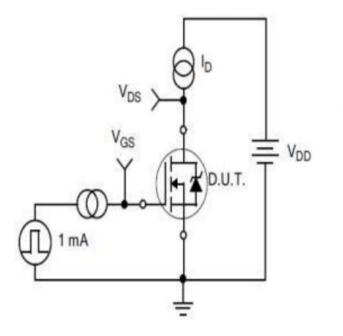


Figure 13. Maximum Effective Transient Thermal Impedance, Junction-to-Case

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# Test ircuits and Waveforms



VGS(TH)

VDS

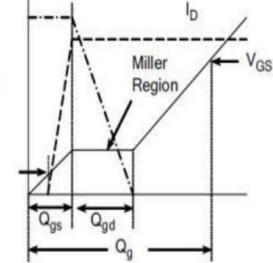


Figure A. Gate Charge Test Circuit

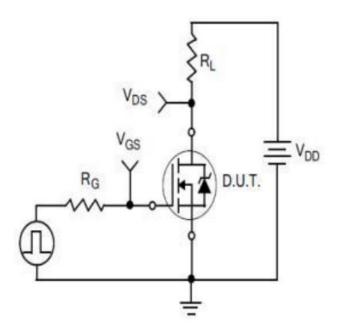


Figure C. Resistive Switching Test Circuit

Figure B. Gate Charge Waveform

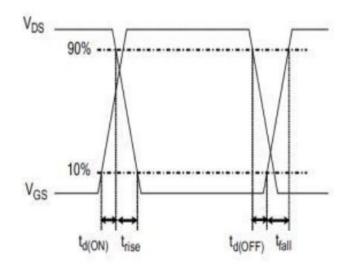
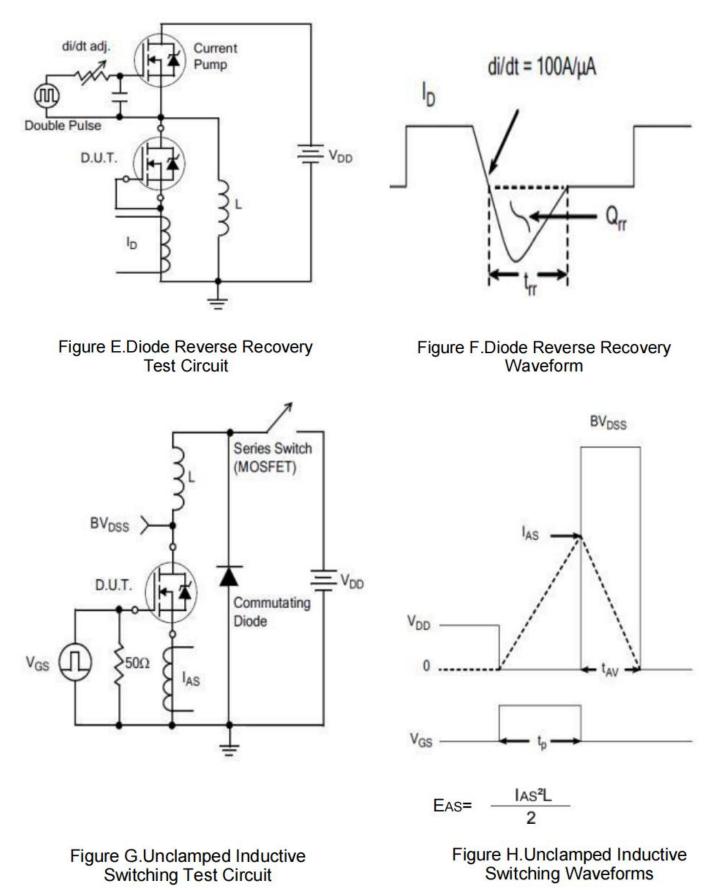


Figure D. Resistive Switching Waveforms

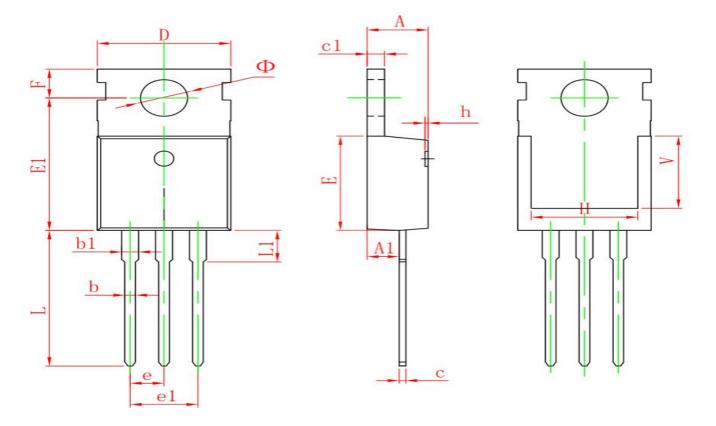


# Test ircuits and Waveforms





# Package outline drawing(TO-220 Unit: mm)



Symbol	Dimensions	In Millimeters	Dimension	s In Inches	
Symbol	Min.	Max.	Min.	Max.	
A	4.400	4.600	0.173	0.181	
A1	2.250	2.550	0.089	0.100	
b	0.710	0.910	0.028	0.036	
b1	1.170	1.370	0.046	0.054	
С	0.330	0.650	0.013	0.026	
c1	1.200	1.400	0.047	0.055	
D	9.910	10.250	0.390	0.404	
E	8.950	9.750	0.352	0.384	
E1	12.650	13.050	0.498	0.514	
е	2.540	TYP.	0.100	) TYP.	
e1	4.980	5.180	0.196	0.204	
F	2.650	2.950	0.104	0.116	
Н	7.900	8.100	0.311	0.319	
h	0.000	0.300	0.000	0.012	
L	12.900	13.400	0.508	0.528	
L1	2.850	3.250	0.112	0.128	
V	6.900 REF.		0.276 REF.		
Ф	3.400	3.800	0.134	0.150	



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